Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

Rev. 4 — 25 November 2011

Product data sheet

1. General description

The 74LVC541A is an octal non-inverting buffer/line driver with 5 V tolerant inputs and outputs. The 3-state outputs are controlled by the output enable inputs $\overline{OE1}$ and $\overline{OE2}$.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

2. Features and benefits

- 5 V tolerant inputs for interlacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

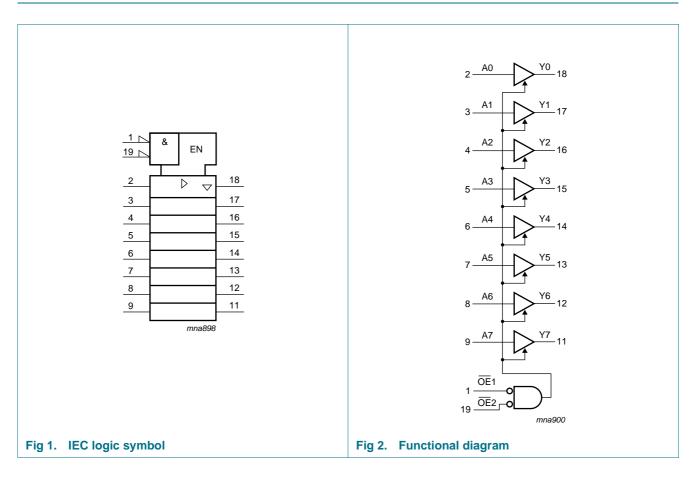


Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

3. Ordering information

Type number	Package								
	Temperature range	Name	Description	Version					
74LVC541AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
74LVC541ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1					
74LVC541APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
74LVC541ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1					

4. Functional diagram

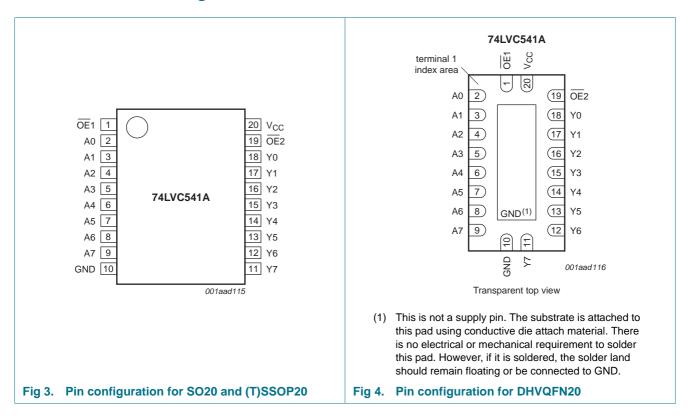


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5. Pinning information



5.1 Pinning

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
OE1	1	output enable input (active LOW)
A[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
Y[0:7]	18, 17, 16, 15, 14, 13, 12, 11	bus output
OE2	19	output enable input (active LOW)
V _{CC}	20	supply voltage

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6. Functional description

	Table 3.	Functional	table ^[1]
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Input OE1	Output		
OE1	OE2	An	Yn
L	L	L	L
L	L	Н	Н
Х	Н	Х	Z
Н	Х	Х	Z

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+5.5	V
Ι _{ΟΚ}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2] -0.5	V _{CC} + 0.5	V
		output 3-state or power-down	[2] -0.5	+6.5	V
l _O	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-60	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	<u>[3]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For (T)SSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating conditions								
Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
V _{CC}	supply voltage		1.65	-	3.6	V			
		functional	1.2	-	-	V			
VI	input voltage		0	-	5.5	V			
V _O	output voltage	output HIGH or LOW state	0	-	V _{CC}	V			
		output 3-state	0	-	5.5	V			
T _{amb}	ambient temperature		-40	-	+125	°C			
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 2.3 V to 2.7 V	0	-	20	ns/V			
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V			

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
in	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{\text{CC}}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL} LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V	
	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
outpu	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8$ mA; $V_{CC} = 2.3$ V	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		I_O = -24 mA; V_{CC} = 3.0 V	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu\text{A};$ $V_{CC} = 1.65 \ \text{V} \text{ to } 3.6 \ \text{V}$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		I_{O} = 8 mA; V_{CC} = 2.3 V	-	-	0.6	-	0.8	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		I_{O} = 24 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.8	V

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Symbol	Parameter	Conditions	-40) °C to +85	°C	−40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
lı	input leakage current	$V_{I} = 5.5 V \text{ or GND};$ $V_{CC} = 3.6 V$	-	±0.1	±5	-	±20	μA
I _{OZ}	OFF-state output current		-	±0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	-	±20	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6$ V	-	0.1	10	-	40	μΑ
ΔI_{CC}	additional supply current	per input pin; V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 2.7 V to 3.6 V	-	5	500	-	5000	μΑ
CI	input capacitance		-	5.0	-	-	-	pF

Static characteristics ... continued Table 6.

At recommended operating conditions, Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. **Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 °C	Unit
		-		Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	An to Yn; see Figure 5	[2]						
dela	delay	$V_{CC} = 1.2 V$		-	14.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		1.5	6.5	13.8	1.5	16.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	3.5	6.8	1.0	7.9	ns
		$V_{CC} = 2.7 V$		1.5	3.5	5.6	1.5	7.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.9	5.1	1.0	6.5	ns
t _{en}	enable time	OEn to Yn; see Figure 6	[2]						
		$V_{CC} = 1.2 V$		-	20.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		1.8	7.7	16.0	1.8	18.5	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.3	8.8	1.5	10.2	ns
		$V_{CC} = 2.7 V$		1.5	4.4	7.5	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.5	7.0	1.0	9.0	ns
t _{dis}	disable time	OEn to Yn; see <u>Figure 6</u>	[2]						
		$V_{CC} = 1.2 V$		-	11.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		3.0	4.9	10.3	3.0	11.9	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.7	5.9	1.0	6.8	ns
		$V_{CC} = 2.7 V$		1.5	3.7	7.0	1.5	9.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.3	6.0	1.0	7.5	ns
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Voltages	are referenced	to GND (ground = 0 V). For test circuit	see <mark>Figu</mark>	<u>re 7</u> .					
Symbol Parameter		Conditions			–40 °C to +85 °C			–40 °C to +125 °C	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	<u>[4]</u>						
	dissipation capacitance	V_{CC} = 1.65 V to 1.95 V		-	7.7	-	-	-	pF
	capacitarice	V_{CC} = 2.3 V to 2.7 V		-	11.3	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	14.4	-	-	-	pF

Table 7. Dynamic characteristics ... continued

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZI} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_i \times \mathsf{N} + \Sigma(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_{\mathsf{o}}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

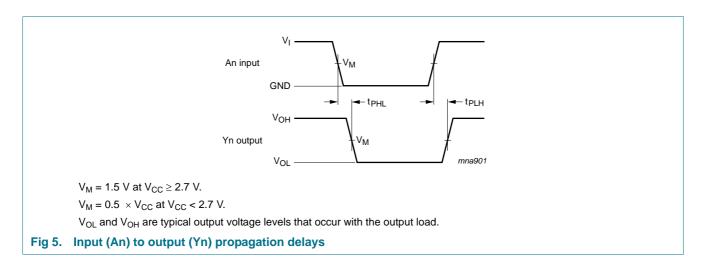
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

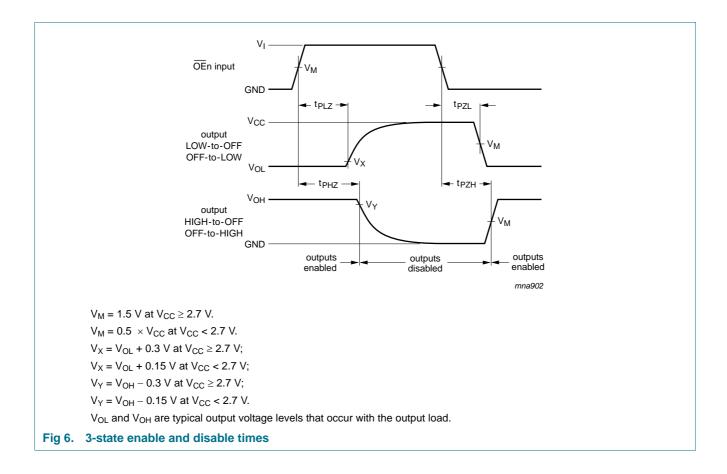
 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

11. AC waveforms



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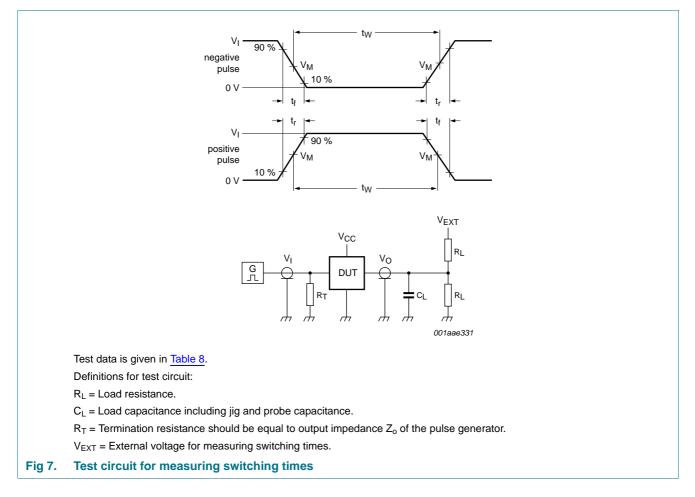


	Table	e 8.	Test	data
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Supply voltage	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND

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12. Package outline

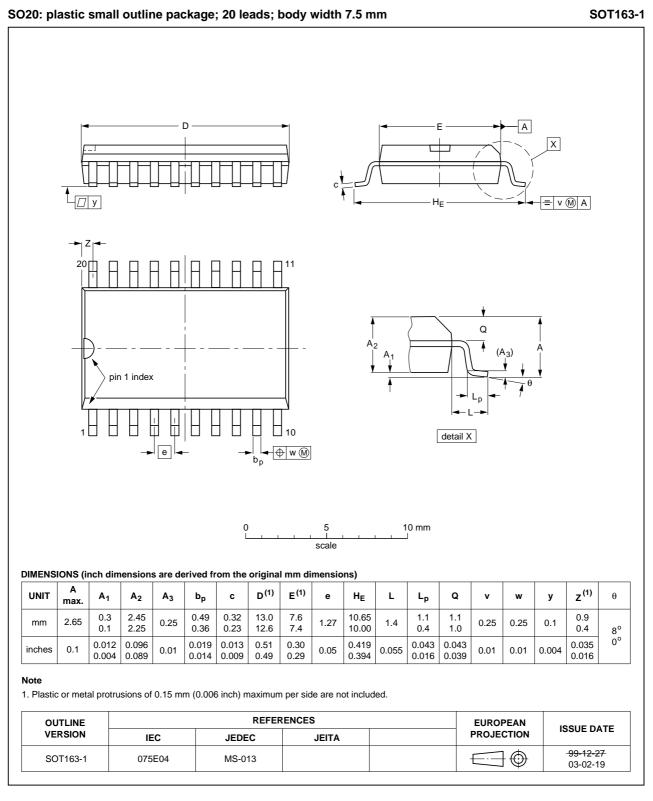


Fig 8. Package outline SOT163-1 (SO20)

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Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

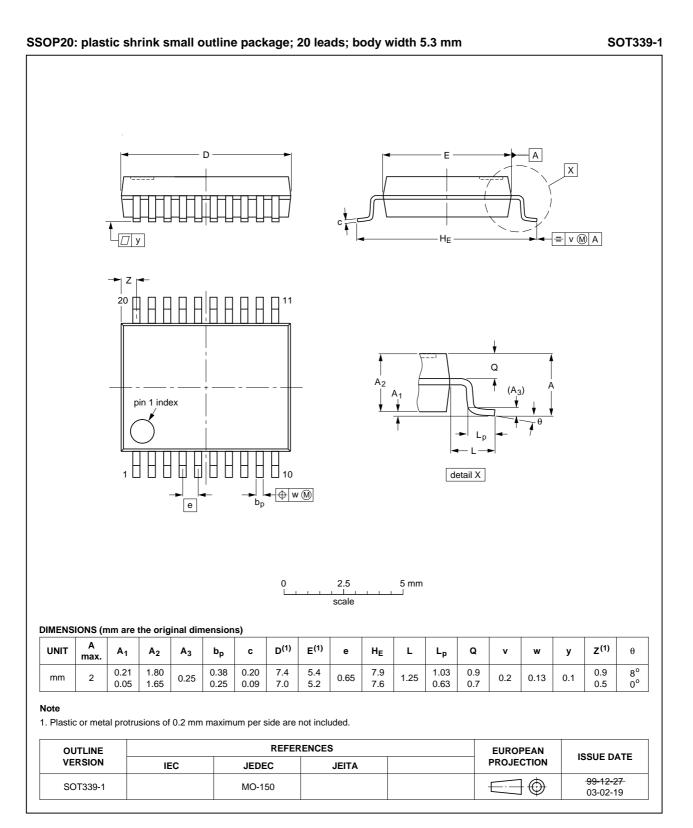


Fig 9. Package outline SOT339-1 (SSOP20)

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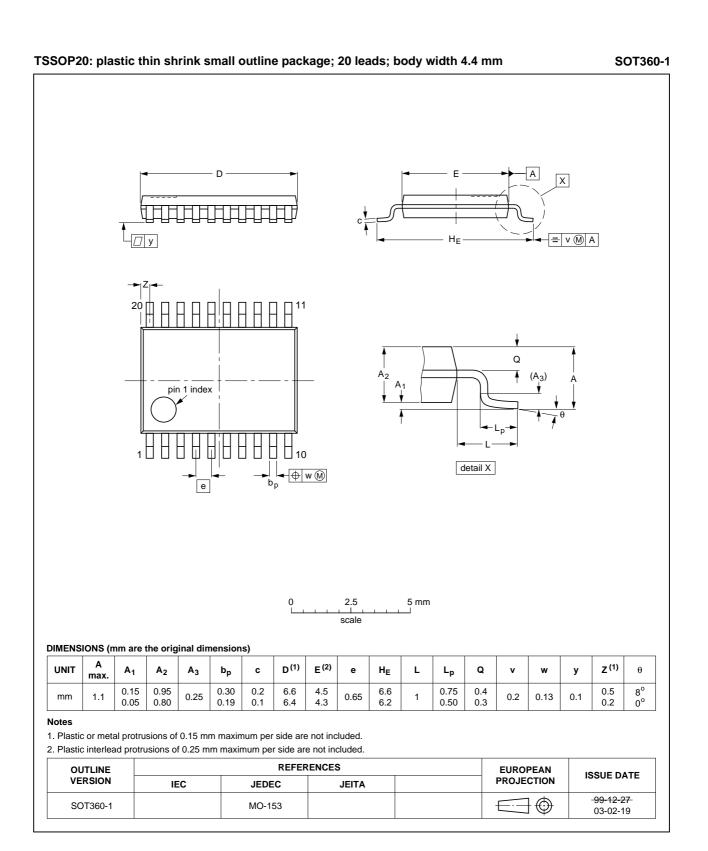
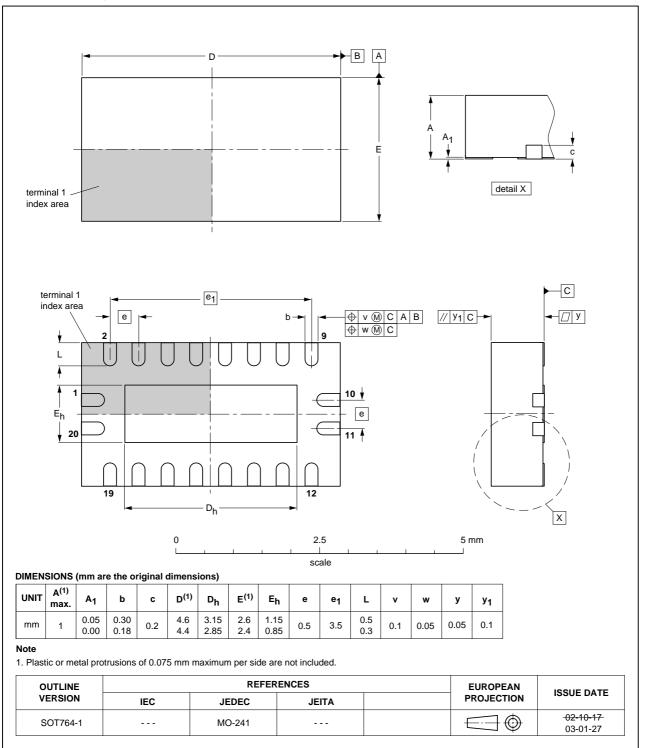


Fig 10. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 11. Package outline SOT764-1 (DHVQFN20)

Octal buffer/line driver with 5 V tolerant inputs/outputs; 3-state

13. Abbreviations

Table 9. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
MM	Machine Model			
HBM	Human Body Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 10. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVC541A v.4	20111125	Product data sheet	-	74LVC541A v.3			
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
	 Legal texts have been adapted to the new company name where appropriate. 						
	 <u>Table 4</u>, <u>Table 5</u>, <u>Table 6</u>, <u>Table 7</u> and <u>Table 8</u>: values added for lower voltage ranges. 						
74LVC541A v.3	20031112	Product specification	-	74LVC541A v.2			
74LVC541A v.2	20030514	Product specification	-	74LVC541A v.1			
74LVC541A v.1	19980729	Product specification	-	-			

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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